ne<mark>x</mark>peria

Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

Rev. 3 — 4 January 2017

Product data sheet

1. General description

The 74HC161 is a synchronous presettable binary counter with an internal look-head carry. Synchronous operation is provided by having all flip-flops clocked simultaneously on the positive-going edge of the clock (CP). The outputs (Q0 to Q3) of the counters may be preset HIGH or LOW. A LOW at the parallel enable input (PE) disables the counting action and causes the data at the data inputs (D0 to D3) to be loaded into the counter on the positive-going edge of the clock. Preset takes place regardless of the levels at count enable inputs (CEP and CET). A LOW at the master reset input (MR) sets Q0 to Q3 LOW regardless of the levels at input pins CP, PE, CET and CEP (thus providing an asynchronous clear function). The look-ahead carry simplifies serial cascading of the counters. Both CEP and CET must be HIGH to count. The CET input is fed forward to enable the terminal count output (TC). The TC output thus enabled will produce a HIGH output pulse of a duration approximately equal to a HIGH output of Q0. This pulse can be used to enable the next cascaded stage. The maximum clock frequency for the cascaded counters is determined by the CP to TC propagation delay and CEP to CP set-up time, according to the following formula:

$$f_{max} = \frac{I}{t_{P(max)}(CPtoTC) + t_{SU}(CEPtoCP)}$$

Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of $V_{\text{CC}}.$

2. Features and benefits

- Complies with JEDEC standard no. 7A
- Input levels:
 - For 74HC161: CMOS level
- Synchronous counting and loading
- 2 count enable inputs for n-bit cascading
- Asynchronous reset
- Positive-edge triggered clock
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C and –40 °C to +125 °C

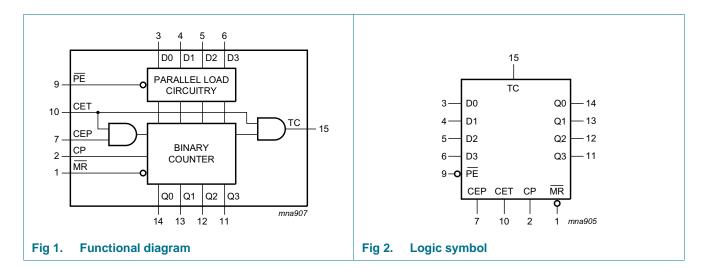


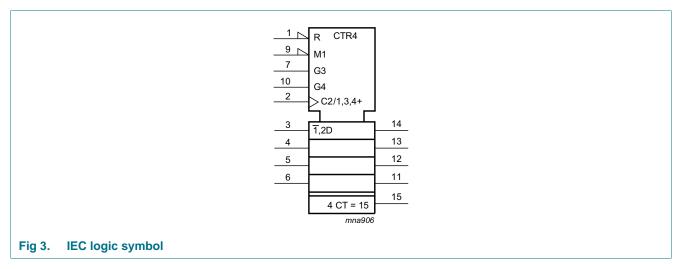
Ordering information 3.

Ordering information Table 1.

Type number	Package								
	Temperature range	Name	Description	Version					
74HC161D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1					
74HC161DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1					
74HC161PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1					

Functional diagram 4.

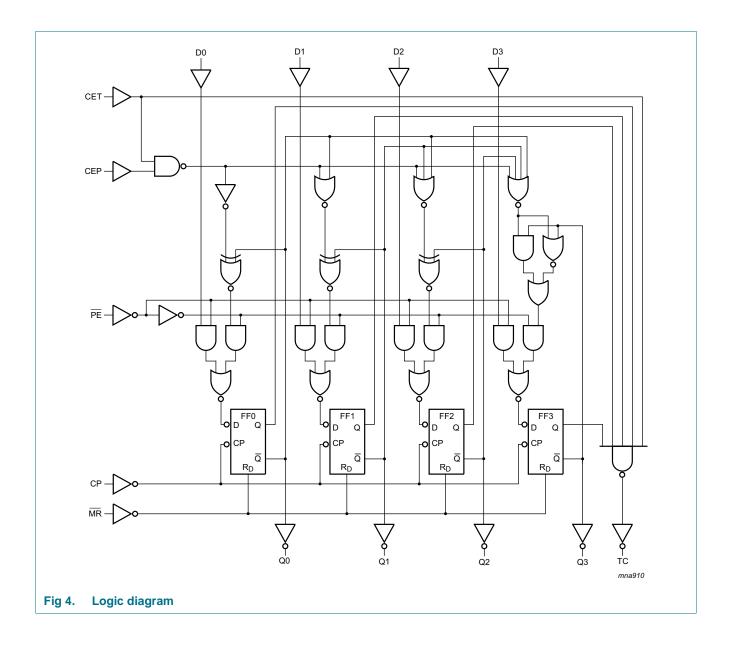




74HC161 **Product data sheet**

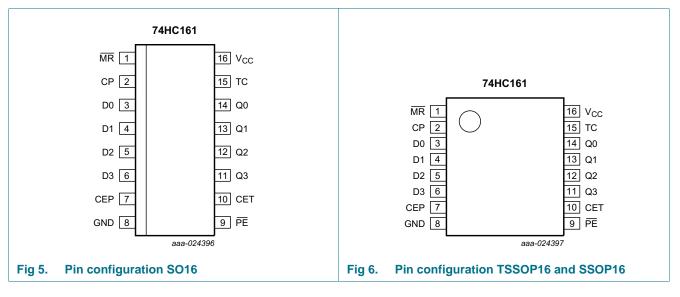
74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
MR	1	asynchronous master reset (active LOW)
СР	2	clock input (LOW-to-HIGH, edge-triggered)
D0, D1, D2, D3	3, 4, 5, 6	data input
CEP	7	count enable input
GND	8	ground (0 V)
PE	9	parallel enable input (active LOW)
CET	10	count enable carry input
Q0, Q1, Q2, Q3	14, 13, 12, 11	flip-flop output
TC	15	terminal count output
V _{CC}	16	supply voltage

6. Functional description

Table 3. Function table^[1]

Operating	Input		Output	Output				
modes	MR	СР	CEP	CET	PE	Dn	Qn	тс
Reset (clear)	L	Х	Х	Х	Х	Х	L	L
Parallel load	Н	\uparrow	Х	Х	I	I	L	L
	Н	\uparrow	Х	Х	I	h	Н	[2]
Count	Н	\uparrow	h	h	h	Х	count	[2]
Hold	Н	Х	I	Х	h	Х	q _n	[2]
(do nothing)	Н	Х	Х	I	h	Х	q _n	L

[1] H = HIGH voltage level

 $\mathsf{h}=\mathsf{HIGH}$ voltage level one set-up time prior to the LOW-to-HIGH clock transition

L = LOW voltage level

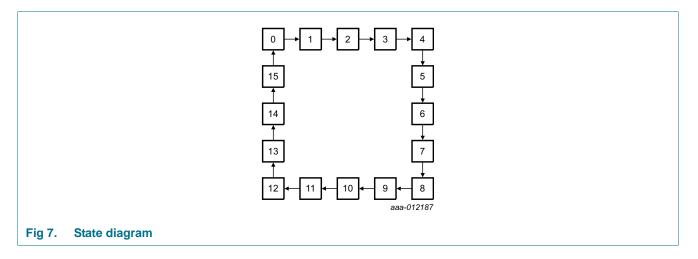
I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition

 q_n = lower case letters indicate the state of the referenced output one set-up time prior to the LOW-to-HIGH clock transition

X = don't care

 \uparrow = LOW-to-HIGH clock transition

[2] The TC output is HIGH when CET is HIGH and the counter is at terminal count (HHHH)



74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

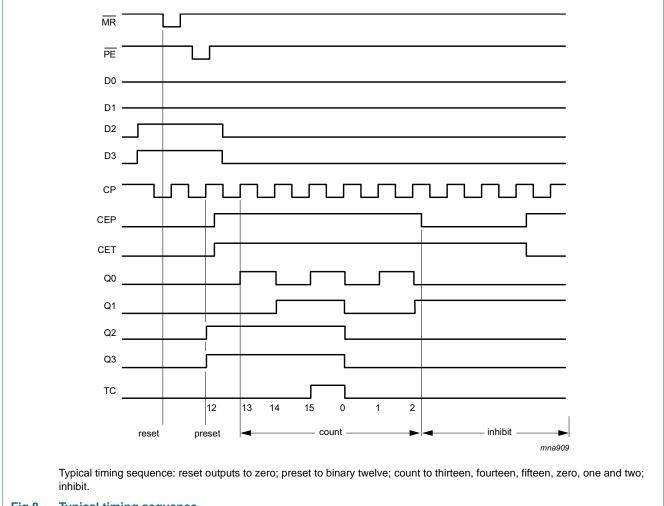


Fig 8. Typical timing sequence

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
l _{IK}	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{CC} + 0.5$ V		-	±20	mA
I _{ОК}	output clamping current	$V_{\rm O}$ < -0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V		-	±20	mA
lo	output current	$V_{O} = -0.5$ V to V_{CC} + 0.5 V		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO16 package	<u>[1]</u>	-	500	mW
		(T)SSOP16 package	<u>[1]</u>	-	500	mW

[1] For SO16 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.

For (T)SSOP16 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.

All information provided in this document is subject to legal disclaimers.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	ns/V
		V _{CC} = 4.5 V	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	-
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	IL LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0; V_{CC} = 4.5 V$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2; V_{CC} = 6.0 V$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current		-	-	8.0	-	80.0	-	160.0	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

7 of 20

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see <u>Figure 14</u>.

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	–40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
t _{pd}	propagation	CP to Qn; see Figure 9 [1]								
	delay	V _{CC} = 2.0 V	-	61	190	-	240	-	285	ns
		V _{CC} = 4.5 V	-	22	38	-	48	-	57	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	19	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	32	-	41	-	48	ns
		CP to TC; see Figure 9								
		V _{CC} = 2.0 V	-	69	215	-	270	-	325	ns
		V _{CC} = 4.5 V	-	25	43	-	54	-	65	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	21	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	20	37	-	46	-	55	ns
		CET to TC; see Figure 10								
		V _{CC} = 2.0 V	-	33	150	-	190	-	225	ns
		V _{CC} = 4.5 V	-	12	30	-	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	10	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	10	26	-	38	-	31	ns
t _{PHL}	HIGH to	MR to Qn; see Figure 11								
	LOW propagation	V _{CC} = 2.0 V	-	63	210	-	265	-	315	ns
	delay	V _{CC} = 4.5 V	-	23	42	-	53	-	63	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	36	-	45	-	54	ns
		MR to TC; see Figure 11								
		$V_{CC} = 2.0 V$	-	63	220	-	275	-	330	ns
		V _{CC} = 4.5 V	-	23	44	-	55	-	66	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	20	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	18	37	-	47	-	56	ns
t _t	transition	see Figure 9 and Figure 10 [2]								
	time	V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns

8 of 20

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Мах	-
t _W	pulse width	CP; HIGH or LOW; see Figure 9								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		MR; LOW; see Figure 11								
		V _{CC} = 2.0 V	80	19	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
t _{rec} recovery time	MR to CP; see Figure 11									
	time	V _{CC} = 2.0 V	100	19	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	7	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	6	-	21	-	26	-	ns
t _{su}	set-up time	Dn to CP; see Figure 12								
		V _{CC} = 2.0 V	80	25	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	9	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	7	-	17	-	20	-	ns
		PE to CP; see Figure 12								
		V _{CC} = 2.0 V	100	30	-	125	-	150	-	ns
		V _{CC} = 4.5 V	20	11	-	25	-	30	-	ns
		V _{CC} = 6.0 V	17	9	-	21	-	26	-	ns
		CEP, CET to CP; see Figure 13								
		V _{CC} = 2.0 V	170	47	-	215	-	255	-	ns
		V _{CC} = 4.5 V	34	17	-	43	-	51	-	ns
		V _{CC} = 6.0 V	29	14	-	37	-	43	-	ns
t _h	hold time	Dn, PE, CEP, CET to CP; see Figure 12 and Figure 13								
		V _{CC} = 2.0 V	0	-14	-	0	-	0	-	ns
		V _{CC} = 4.5 V	0	-5	-	0	-	0	-	ns
		V _{CC} = 6.0 V	0	-4	-	0	-	0	-	ns
f _{max}	maximum	CP; see Figure 9								
	frequency	V _{CC} = 2.0 V	4.6	13	-	3.6	-	3.0	-	MHz
		V _{CC} = 4.5 V	23	40	-	18	-	15	-	MHz
		V _{CC} = 5.0 V; C _L = 15 pF	-	44	-	-	-	-	-	MHz
		V _{CC} = 6.0 V	27	48	-	21	-	18	-	MHz

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 14.

Presettable synchronous 4-bit binary counter; asynchronous reset

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 14.

Symbol	Parameter	Conditions		25 °C		–40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
C _{PD}	power dissipation capacitance	$V_1 = GND$ to V_{CC} ; $V_{CC} = 5 V$; $f_i = 1 MHz$	-	33	-	-	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

 f_o = output frequency in MHz;

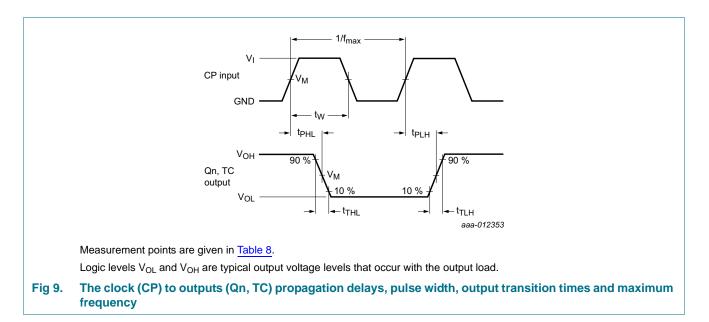
 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

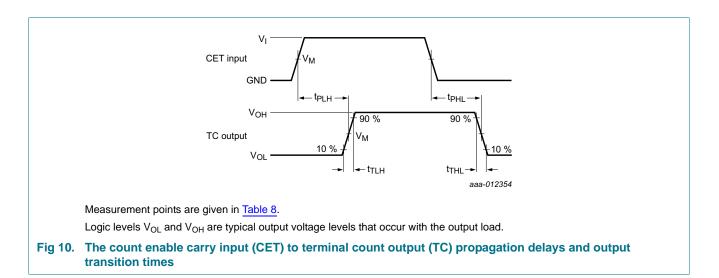
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of outputs.

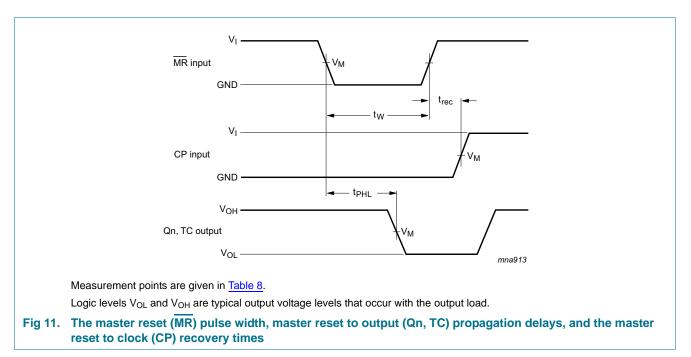
11. Waveforms



74HC161

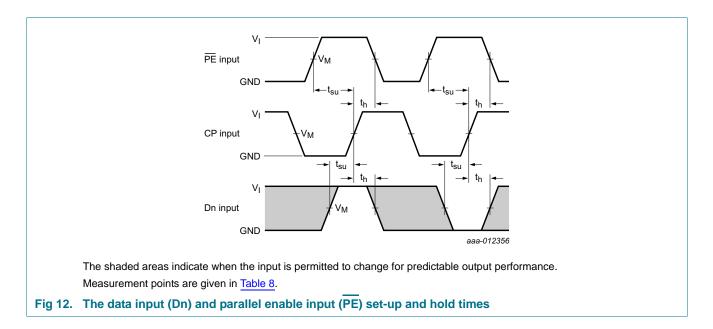
Presettable synchronous 4-bit binary counter; asynchronous reset





74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset



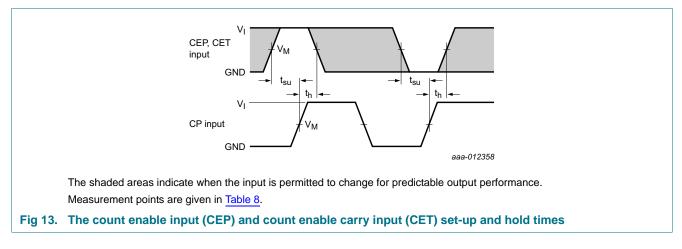


Table 8. Measurement points

Input	Output	
V _M	VI	V _M
$0.5 \times V_{CC}$	GND to V _{CC}	$0.5 \times V_{CC}$

74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

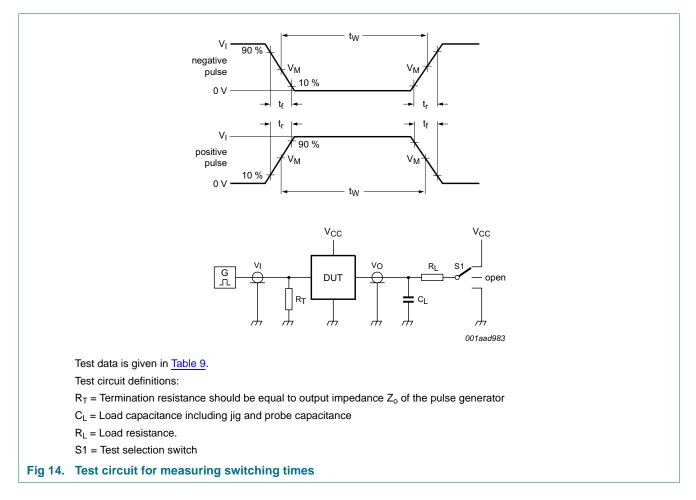


Table 9. Test data

Input		Load	S1 position	
VI	t _r , t _f	CL	R _L	t _{PHL} , t _{PLH}
V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open

12. Package outline

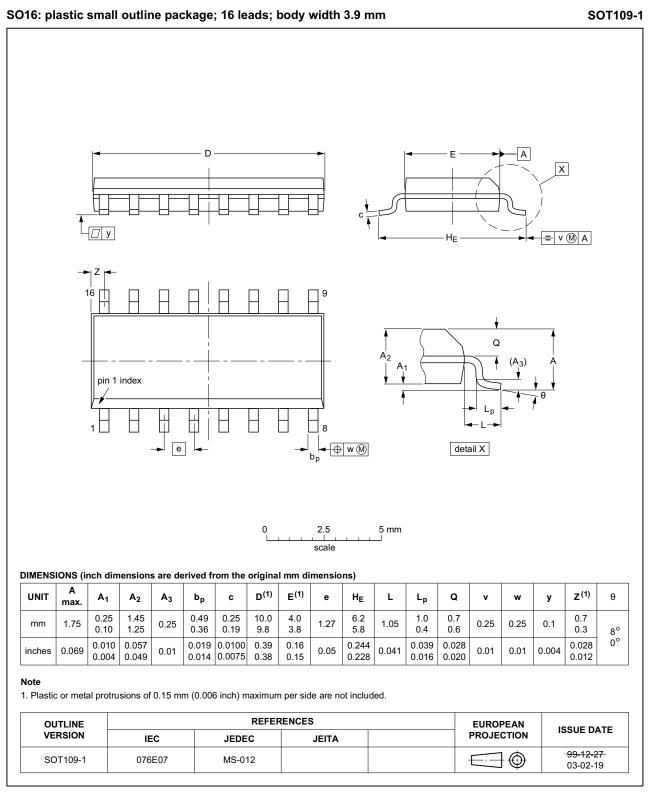


Fig 15. Package outline SOT109-1 (SO16)

All information provided in th	is document is subj	ect to legal disclaimers.

74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

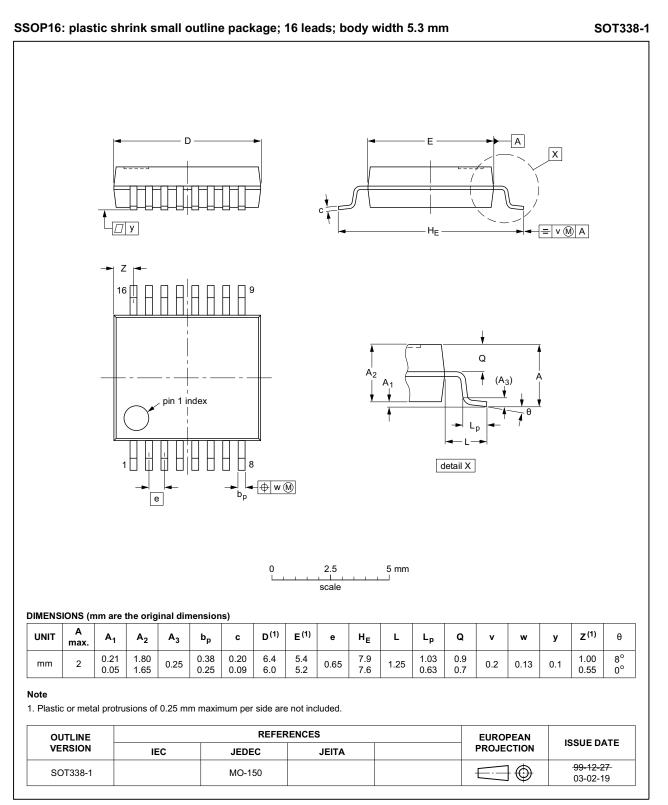


Fig 16. Package outline SOT338-1 (SSOP16)

All information provided in this document is subject to legal disclaimers.

74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

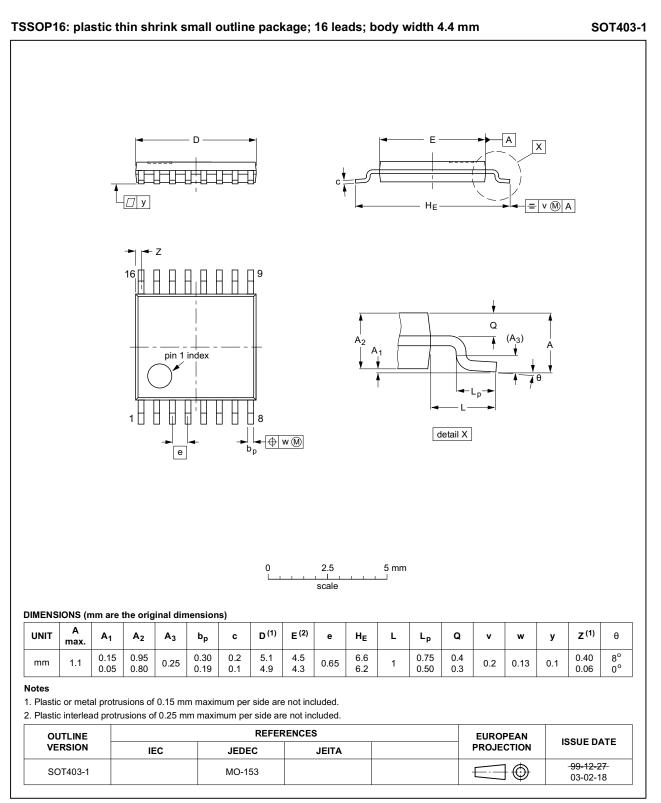


Fig 17. Package outline SOT403-1 (TSSOP16)

All information provided in this document is subject to legal disclaimers.

13. Abbreviations

Table 10. Abbreviations		
Acronym	Description	
CMOS	Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC161 v.3	20170104	Product data sheet	-	74HC_HCT161 v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have been adapted to the new company name where appropriate. 				
	 Type numbers 74HCT161D, 74HCT161DB, 74HCT161PW removed. 				
74HC_HCT161 v.2	19901201	Product specification	-	-	

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

15.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

15.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof. Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product sole and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP Semiconductors N.V. 2017. All rights reserved.

74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

15.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

16. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

74HC161

Presettable synchronous 4-bit binary counter; asynchronous reset

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 4
5.1	Pinning 4
5.2	Pin description 4
6	Functional description 5
7	Limiting values 6
8	Recommended operating conditions 7
9	Static characteristics 7
10	Dynamic characteristics 8
11	Waveforms 10
12	Package outline 14
13	Abbreviations 17
14	Revision history 17
15	Legal information 18
15.1	Data sheet status 18
15.2	Definitions 18
15.3	Disclaimers
15.4	Trademarks 19
16	Contact information 19
17	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP Semiconductors N.V. 2017.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 4 January 2017 Document identifier: 74HC161

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Counter ICs category:

Click to view products by NXP manufacturer:

Other Similar products are found below :

 HEF4516BT
 069748E
 569054R
 634844F
 74HC40102N
 74HCT4024N
 NLV14040BDR2G
 TC74HC4040AF(EL,F)
 TC74VHC4040F(E,K,F

 74VHC163FT
 XD4059
 CD4015BF3A
 74HC193PW,118
 74VHC163FT(BJ)
 SN54HC4024J
 74HC4017D.652
 74HC4020D.652

 74HC393D.652
 74HC4040D.652
 74HC4040D.653
 74HC4040D.653
 74HC191D.652
 74HC4060D.652

 74HCT4040D.652
 HEF4060BT.653
 HEF4521BT.652
 HEF4518BT.652
 HEF4520BT.652
 HEF4017BT.652

 74VHC4020FT(BJ)
 74HCT4040PW,118
 74HCT193PW,118
 74HC393BQ-Q100X
 SN74AS161NSR
 74HC390DB,112
 74HC4060D

 Q100,118
 74HC160D,652
 74HC390DB,118
 TC74HC7292AP(F)
 SN74ALS169BDR
 HEF4060BT-Q100J
 74HC4017BQ-Q100X

 74HC163PW.112
 74HC191PW.112
 74HC393DB.118
 74HC4024D.652